

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C ⁽¹⁾	STORAGE TEMPERATURE RANGE	-10 °C TO 60 °C ⁽²⁾	
	VOLTAGE	100 V AC	STORAGE HUMIDITY RANGE	40 % TO 70 % ⁽²⁾	
	CURRENT	0.5 A (SIGNAL CONTACT) ⁽³⁾  3 A (MF CONTACT) 	OPERATING HUMIDITY RANGE	RELATIVE HUMIDITY 85% max (NOT DEWED)	
SPECIFICATIONS					
ITEM	TEST METHOD		REQUIREMENTS		QT AT
CONSTRUCTION					
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.		x x
MARKING	CONFIRMED VISUALLY.				x x
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE	100 mA(DC OR 1000Hz)		SIGNAL CONTACT : 90 mΩ MAX. MF CONTACT : 30 mΩ MAX. 	x	—
INSULATION RESISTANCE	250 V DC.		1000 MΩ MIN.	x	—
VOLTAGE PROOF	300 V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	x	—
MECHANICAL CHARACTERISTICS					
INSERTION AND WITHDRAWAL FORCES	MEASURED BY APPLICABLE CONNECTOR.		INSERTION FORCE: 40 N MAX. WITHDRAWAL FORCE: 4 N MIN.	x	—
MECHANICAL OPERATION	500 TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩ MAX. MF CONTACT : 40 mΩ MAX.  ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
VIBRATION	FREQUENCY 10 TO 55 TO 10Hz, APPROX 5min SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
SHOCK	490 m/s ² , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			x	—
ENVIRONMENTAL CHARACTERISTICS					
DAMP HEAT (STEADY STATE)	EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.		① CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩ MAX. MF CONTACT : 40 mΩ MAX. 	x	—
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55 → +85 °C TIME 30 → 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)		② INSULATION RESISTANCE : 1000 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
SULFUR DIOXIDE	EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)		NO HEAVY CORROSION.	x	—
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING : PEAK TMP : 260°C MAX REFLOW TMP: 220°C MIN FOR 60sec 2) SOLDERING IRONS : 360°C MAX. FOR 5 sec.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.	x	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.		A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	x	—
COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 6	DIS-F-004173		TH. SANO	KI. HIROKAWA	09. 09. 15
REMARKS ⁽¹⁾ INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING. ⁽²⁾ "STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB. ⁽³⁾ THE RATED CURRENT APPLIES TO PER CONTACT. 			APPROVED	HS. OKAWA	09. 04. 28
			CHECKED	HS. OZAWA	09. 04. 28
			DESIGNED	KI. HIROKAWA	09. 04. 28
			DRAWN	KI. HIROKAWA	09. 04. 28
Unless otherwise specified, refer to JIS-C-5402.					
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-159082-00
	SPECIFICATION SHEET		PART NO.	FX18-60S-0. 8SH	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL579-0010-3-00	 1/1